



THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:
Chad A. Cobbley et al.

Serial No.: 10/672,750

Filed: September 25, 2003

For: STACKED DIE MODULE AND
TECHNIQUES FOR FORMING A
STACKED DIE MODULE

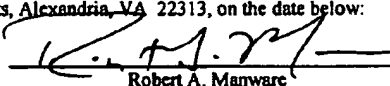
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Group Art Unit: 2811

Examiner: Blum, David S.

Atty Docket: MICS:0078—1/FLE/MAN
(01-0752.01)

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313

CERTIFICATE OF TRANSMISSION OR MAILING 37 C.F.R. 1.8	
I hereby certify that this correspondence is being transmitted by facsimile to the United States Patent and Trademark Office in accordance with 37 C.F.R. 1.6(d) or is being deposited with the U.S. Postal Service as First Class Mail in an envelope addressed to: Mail Stop Amendment, Commissioner for Patents, Alexandria, VA 22313, on the date below:	
September 1, 2004	
Date	Robert A. Manware

RESPONSE TO OFFICE ACTION DATED JUNE 1, 2004

Sir:

In response to the Office Action dated June 1, 2004, please amend the above-identified application as follows:

Amendments to the Specification begin on page 2 of this paper.

Amendments to the Claims are reflected in the listing of claims, which begins on page 3 of this paper.

Remarks begin on page 8 of this paper.

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01 FC:1201 430.00 DA
02 FC:1202 36.00 DA

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